





Small Signal Schottky Diode



Features

Moisture sensitivity level 1

Reverse voltage: 40V/30V/20VAverage forward current: 350mA

Application

High frequency and low voltage rectifier

Mechanical data

• Package: SOD-323

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Value	
			SD103AWS	S4
Device marking code			SD103BWS	S5
			SD103CWS	S6
Forward current	I _F	mA	350	
Non-repetitive surge peak forward current @ t=8.3ms half-sine wave			1.5	
Non-repetitive surge peak forward current @ t=1ms square wave	I _{FSM}	A	5	
Power dissipation	P_{D}	mW	200	
Junction temperature	TJ	°C	-55 to +125	
Storage temperature	T _{STG}	°C	-55 to +150	





■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions		Min	Тур	Max
Reverse voltage	V_R	V	SD103AWS	I _R =100uA	40		
			SD103BWS		30		
			SD103CWS		20		
Forward voltage	V_{F1}	V	I _F =20mA				0.37
	V_{F2}	V	I _F =200mA				0.60
Reverse leakage current			SD103AWS	V _R =30V			5
	I _R	uA	SD103BWS	V _R =20V			5
			SD103CWS	V _R =10V			5
Junction capacitance	Cj	pF	V _R =0V, f=1MHZ				50

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	RθJ-A ⁽¹⁾	°C/W	500
Thermal resistance, junction-to-case	RθJ-C ⁽¹⁾	°C/W	400

Note:

(1) Thermal resistance from junction to ambient and from junction to case mounted on P.C.B. with 8mm*9mm copper pad areas





■Characteristics

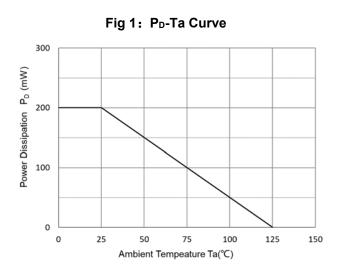


Fig 2: Capacitance Capability

Ta=25°C

Ta=25°C

Reverse Voltage V_R(V)

Fig 3: Typical Forward Characteristics

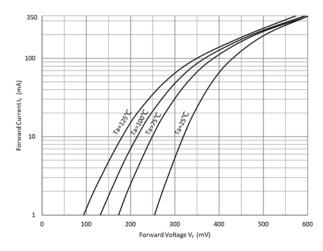
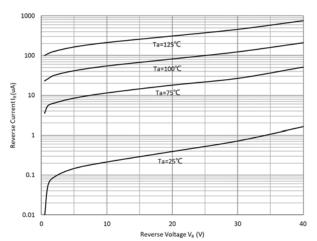


Fig 4: Typical Reverse Characteristics



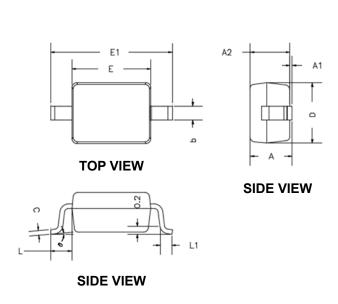




■Ordering Information

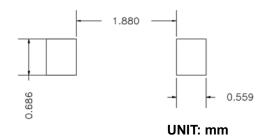
Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
SD103AWS THRU SD103CWS	F2	Approximate 0.0048	3000	30000	120000	7" reel
SD103AWS THRU SD103CWS	F3	Approximate 0.0048	10000	1	210000	13" reel

■ Outline Dimensions



DIMENSIONS						
DIM	INC	HES	ММ			
	MIN	MAX	MN	MAX		
А		0.0393		1.0000		
A1	0.0000	0.0039	0.0000	0.1000		
A2	0.0314	0.0354	0.8000	0.9000		
lo	0.0098	0.0157	0.2500	0.4000		
С	0.0031	0.0059	0.0800	0.1500		
D	0.0472	0.0551	1,2000	1.4000		
Ε	0.0629	0.0709	1,6000	1.8000		
El	0.0984	0.1063	2,5000	2.7000		
L	0.018	7TYP	0.475TYP			
L1	0.0098	0.0157	0.250	0.400		
θ	0*	8*	0*	8*		

■ Suggested Pad Layout







Disclaimer

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